

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
AKIO YOSHIDA	01/12/2017
KIYOSHI IGARASHI	01/12/2017
SHINGO MUROMOTO	01/12/2017
TAISUKE KIMURA	01/12/2017
NOBUYUKI SHINTAKU	01/12/2017
RECEIVING PARTY DATA	
Name:	NIPPON MEKTRON, LTD.
Street Address:	12-15, SHIBA DAIMON, 1-CHOME
City:	MINATO-KU, TOKYO
State/Country:	JAPAN
Postal Code:	105-8585
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15503560
CORRESPONDENCE DATA	
Fax Number:	(860)286-0115
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	860-286-2929
Email:	usptopatentmail@cantorcolburn.com
Correspondent Name:	CANTOR COLBURN LLP
Address Line 1:	20 CHURCH STREET
Address Line 2:	22ND FLOOR
Address Line 4:	HARTFORD, CONNECTICUT 06103
ATTORNEY DOCKET NUMBER:	IWP0180US
NAME OF SUBMITTER:	DANIEL P. LENT
SIGNATURE:	/Daniel P. Lent/
DATE SIGNED:	02/13/2017
Total Attachments: 2	

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ASSIGNMENT

WHEREAS We, Akio YOSHIDA, Kiyoshi IGARASHI, Shingo MUROMOTO, Taisuke KIMURA, and Nobuyuki SHINTAKU c/o NIPPON MEKTRON, LTD., 12-15, Shiba Daimon 1-chome, Minato-ku, Tokyo 105-8585 Japan (hereinafter referred to as "ASSIGNORS") have invented certain new and useful improvements in:

EXTENSIBLE FLEXIBLE PRINTED CIRCUIT BOARD AND METHOD FOR MANUFACTURING EXTENSIBLE FLEXIBLEPRINTED CIRCUIT BOARD

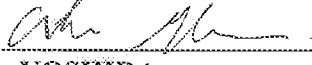
which claims priority to Japanese Application No. 2014-164114, filed August 12, 2014, and for which I am about to file or have filed an application for Letters Patent of the United States;

AND WHEREAS, NIPPON MEKTRON, LTD. (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Japan, having a place of business at 12-15, Shiba Daimon, 1-chome, Minato-ku, Tokyo 105-8585 Japan, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

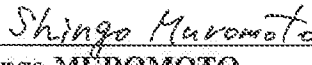
NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention, the applications, and any and all patents that may be issued therefrom, in the United States and in all foreign countries, including any and all revivals, refilings, continuations, continuations-in part, divisions, and reissues thereof, to the said ASSIGNEE; and we, the ASSIGNORS, do hereby agree that we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

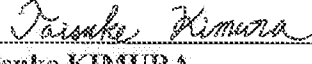
The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like


so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: January 12, 2017  L.S.
Akio YOSHIDA

Date: January 12, 2017  L.S.
Kiyoshi IGARASHI

Date: January 12, 2017  L.S.
Shingo MUROMOTO

Date: January 12, 2017  L.S.
Taisuke KIMURA

Date: January 12, 2017  L.S.
Nobuyuki SHINTAKU